

**ECE/ME 550 Fall 2008**  
**Homework #2**  
**Due October 3, 5:00 pm**

From the text Foundation of MEMS, do the following problems:

3.13, 3.15, 3.17, 3.18, 3.19, 3.23

10.2, 10.5, 11.2

2.1 Literature Search – Find five published papers that describe MEMS devices created using wafer bonding. List the reference for each paper and describe the materials and conditions used for bonding in each case.